

#### **FEATURES**

- General Primary Side Constant-Current (CC)
  Control Supports DCM and CCM Operation
- ±5% CC Regulation, ±1% CV Regulation with Fast Dynamic Response
- CC Algorithm Compensates for Line Variation and Transformer Inductance Tolerance
- Less than 75mW Standby Power for sub 60W Application
- Current Mode Control
- Built-in Frequency Shuffling
- Fixed 65KHz Switching Frequency
- Green Mode and Burst Mode Control
- On-chip Thermal Shutdown
- Cycle-by-Cycle Current Limiting
- Built-in Leading Edge Blanking
- Built-in Slope Compensation
- Very Low Startup and Operation Current
- Available with SOT23-6 Package

#### **APPLICATIONS**

- Chargers and Adapter
- Motor Driver Power Supply

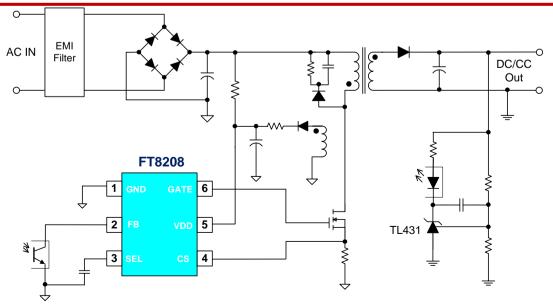
#### **GENERAL DESCRIPTION**

FT8208 is a high performance current mode PWM controller for offline flyback converter applications. The IC has built-in General Primary Side CC control, which simplifies isolated power supply design that requires CC regulation of the output.

In FT8208, PWM switching frequency with shuffling is fixed to 65KHz and is trimmed to tight range. The IC has built-in green and burst mode control for light and zero loadings, which can achieve less than 75mW standby power for sub 60W applications..

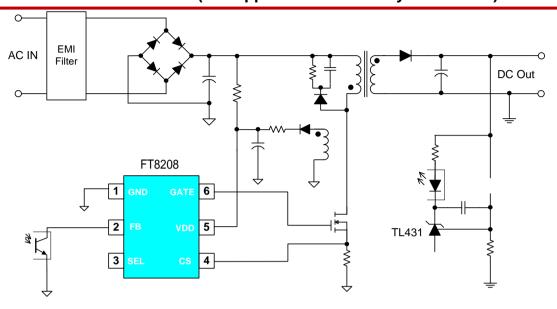
FT8208 integrates functions and protections of Under Voltage Lockout (UVLO), VDD over Voltage Protection (VDD OVP), Cycle-by-cycle Current Limiting (OCP), Short Load Protection (SLP), Over Load Protection (OLP), On-Chip Thermal Shutdown (OTP), Soft Start, VDD Clamping, etc.

# TYPICAL APPLICATION CIRCUIT (For Applications with CC/CV Control)



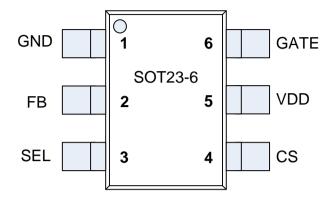


# **TYPICAL APPLICATION CIRCUIT (For Applications with Only CV Control)**

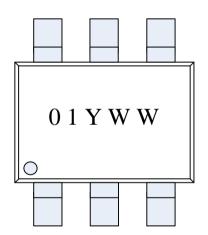




# **Pin Configuration**



# **Marking Information**



Dot: Pin1 Mark FT8208

01: Part number

YWW: Year&Week Code

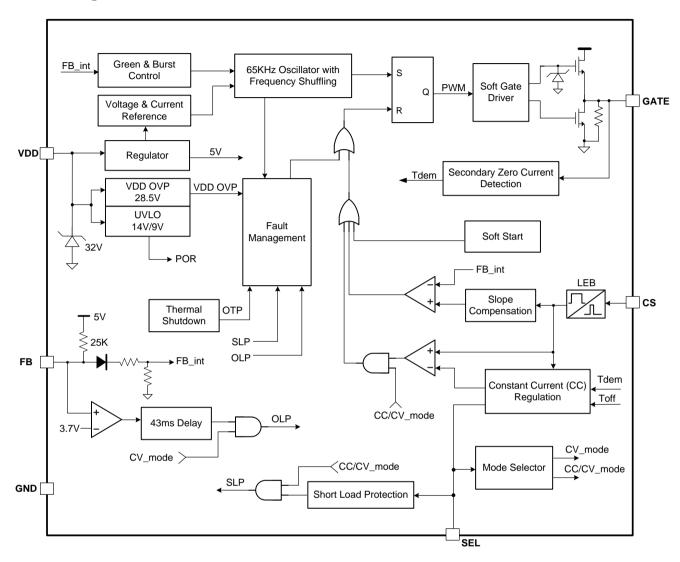
# Pin Description (FT8208)

Fili Description (F16206)						
Pin Number	Pin Name	I/O	Description			
1	GND	Р	The ground of the IC			
2	FB	I	Feedback pin. The loop regulation is achieved by connecting a photo- coupler to this pin. PWM duty cycle is determined by this pin voltage and the current sense signal at Pin 4.			
3	SEL	I	Connect a capacitor between SEL and GND, the IC will work in CC/C mode. If SEL pin is floating, the IC will work in CV mode only.			
4	CS	I	Current sense input pin.			
5	VDD	Р	IC power supply pin.			
6	GATE	0	Totem-pole gate driver output to drive the external MOSFET.			

- 3 -



# **Block Diagram**



**Ordering Information** 

Part Number	Description
FT8208LGA	SOT23-6, Halogen free, 3000Pcs/Reel

- 4 -

**Absolute Maximum Ratings** (Note 1)

Parameter	Value	Unit
VDD DC Supply Voltage	30	V
VDD DC Clamp Current	10	mA
FB, CS, SEL voltage range	-0.3 to 7	V
GATE voltage range	20	V
Package Thermal Resistance (SOT23-6)	250	°C/W
Maximum Junction Temperature	150	°C
Operating Temperature Range	-40 to 85	°C
Storage Temperature Range	-65 to 150	°C
Lead Temperature (Soldering, 10sec.)	260	°C
ESD Capability, HBM (Human Body Model)	3	kV
ESD Capability, MM (Machine Model)	250	V

**Recommended Operation Conditions** (Note 2)

Parameter	Value	Unit
Supply Voltage, VDD	10 to 26	V
Operating Ambient Temperature	-40 to 85	°C

ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, VDD=18V, if not otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit	
Supply Voltage Section(VDD Pin)							
I <sub>VDD_st</sub>	Start-up current into VDD pin			2	20	uA	
I <sub>VDD_Op</sub>	Operation Current	V <sub>FB</sub> =3V,GATE=1nF		1.2	2	mA	
I <sub>VDD_standby</sub>	Standby Current			0.6	1	mA	
$V_{DD\_ON}$	VDD Under Voltage Lockout Exit		13	14	15	V	
$V_{DD\_OFF}$	VDD Under Voltage Lockout Enter		8	9	10	V	
$V_{DD\_OVP}$	VDD OVP Threshold		27	28.5	30	V	
$V_{DD\_Clamp}$	VDD Zener Clamp Voltage	I(V <sub>DD</sub> ) = 7 mA	30	32	34	V	
Feedback Input Section (FB Pin)							
V <sub>FB_Open</sub>	FB Open Voltage		4.5	5.4	6	V	



I <sub>FB_Short</sub>	FB Short Circuit Current	Short FB Pin to GND, Measure Current		0.4		mA
$Z_{FB\_IN}$	FB Input Impedance			25		Kohm
A <sub>CS</sub>	PWM Gain	$\Delta$ V <sub>FB</sub> / $\Delta$ V <sub>CS</sub>		2.0		V/V
$V_{skip}$	FB Under Voltage GATE Clock is OFF			1.0		V
$V_{TH\_OLP}$	Power Limiting FB Threshold Voltage			3.6		V
$T_{D\_OLP}$	Power Limiting Debounce Time	SEL Pin is floating		43		ms
Current Se	nse Input Section (CS Pin)					
$T_{LEB}$	CS Input Leading Edge Blanking Time			250		ns
$V_{cs(max)}$	Current limiting threshold		0.97	1.0	1.03	V
T <sub>D_OC</sub>	Over Current Detection and Control Delay	GATE=1nF		70		ns
Oscillator S	Section					
F <sub>osc</sub>	Normal Oscillation Frequency		60	65	70	KHz
$\Delta$ F(shuffle) $/F_{OSC}$	Frequency Shuffling Range		-4		4	%
T(shuffle)	Frequency Shuffling Period			32		ms
D <sub>MAX</sub>	Maximum Switching Duty Cycle			66.7		%
F <sub>Bust</sub>	Burst Mode Base Frequency			22		KHz
CC Loop R	egulation Section (SEL = Ca	apacitor)				
V <sub>CC_Reg_SEL</sub>	Internal Reference for CC Loop Regulation	SEL Pin=Capacitor	194	200	206	mV
I <sub>CC_SEL_Source</sub>	Internal Source Current for CC Loop Regulation	SEL Pin=Capacitor		20		uA
V <sub>CC_SLP_SEL</sub>	Short Load Protection (SLP) Threshold	SEL Pin=Capacitor		0.7		V
T <sub>CC_Short_SEL</sub>	Short Load Protection (SLP) Debounce Time	SEL Pin=Capacitor		43		ms
On-Chip Thermal Shutdown						
T <sub>SD</sub>	Thermal Shutdown	(Note 3)		165		°C

- 6 -



T <sub>RC</sub>	Thermal Recovery	(Note 3)		140		°C
GATE Driver Section (GATE Pin) (Note 3)						
V <sub>OL</sub>	Output Low Level	Igate_sink=20mA			1	V
V <sub>OH</sub>	Output High Level	Igate_source=20mA	7.5			V
$V_{G\_Clamp}$	Output Clamp Voltage Level	VDD=24V		16		V
T_r	Output Rising Time	GATE=1nF		150		ns
T_f	Output Falling Time	GATE=1nF		60		ns

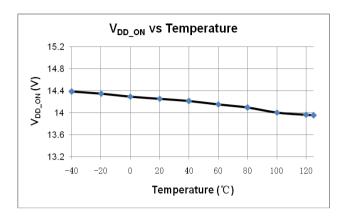
**Note1.** Stresses listed as the above "Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to maximum rating conditions for extended periods may remain possibility to affect device reliability.

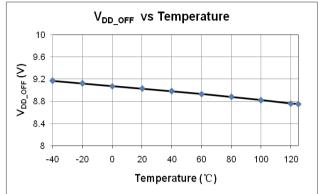
Note2. The device is not guaranteed to function outside its operating conditions.

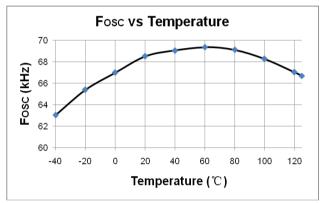
Note3. Guaranteed by the Design.

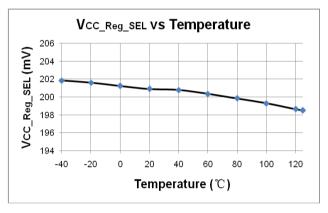


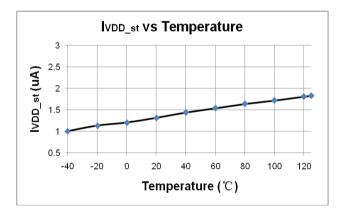
## **CHARACTERIZATION PLOTS**

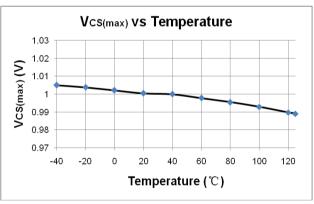


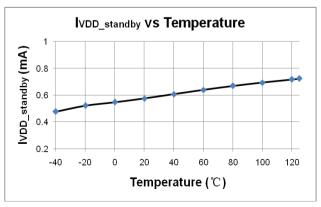














#### PERATION DESCRIPTION

FT8208 is a high performance current mode PWM controller for offline flyback charger, motor driver power supply, and adapter applications. The IC has built-in General Primary Side CC control, which simplifies isolated power supply design that requires CC regulation of the output.

## System Start-Up Operation and IC Operation Current

Before the IC starts to work, it consumes only startup current (typically 2uA) which allows a large value startup resistor to be used to minimize the power loss and the current flowing through the startup resistor charges the VDD hold-up capacitor from the high voltage DC bus. When VDD reaches V<sub>DD\_ON</sub> (typical 14V), FT8208 begins switching and the IC operation current is increased to be 1.2mA (typical). The hold-up capacitor continues to supply VDD before the auxiliary winding of the transformer takes the control of VDD voltage. When the IC enters into burst mode, the IC operation current will decrease further, thus less than 75mW standby power can be achieve in sub 60W applications.

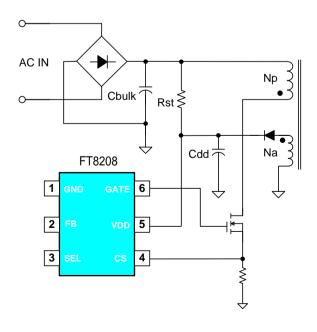
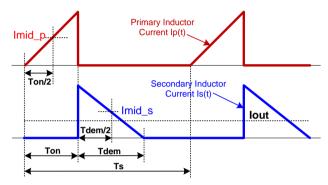


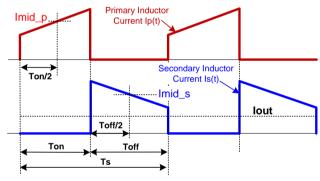
Fig.1

# General Primary Side Constant Current Modulation for DCM/CCM

Compared to conventional flyback DCM Primary Side Regulation (PSR) Constant Current (CC) method, a General Primary Side Constant Current Modulation algorithm is adopted in FT8208, which supports transformer DCM and CCM operation simultaneously.



**Waveform of DCM Flyback Converter** 



**Waveform of CCM Flyback Converter** 

Fig.2

Fig.2 illustrates the key waveform of a flyback converter operating in DCM and CCM, respectively. The output current lout of each mode is estimated by calculating the average current of secondary or primary inductor over one switching cycle:

$$I_{OUT} = \frac{\int_0^{T_s} I_s(t) dt}{T_s} = N \times \frac{\int_0^{T_s} I_p(t) dt}{T_s}$$
 (1)

In Eq.(1) above, Is(t) is the secondary inductor or rectification diode current, Ip(t) is the primary

- 9 - 09/05/2014



inductor current, N is primary-to-secondary transformer turn ratio.

The average secondary inductor current in both DCM and CCM can be expressed in a same form, as a product of secondary inductor discharge time  $T_{\text{DIS}}$  and secondary inductor current at the middle of  $T_{\text{DIS}}$ , such as:

$$\int_{0}^{T_{S}} I_{S}(t) dt = I_{mid\_S} \times T_{DIS} = N \times I_{mid\_P} \times T_{DIS}$$
 (2)

In Eq.(2),  $I_{mid\_S}$  and  $I_{mid\_P}$  are the secondary and primary inductor current at the middle of  $T_{DIS}$  and  $T_{ON}$  respectively, as shown in Fig.2.  $T_{DIS}$  can be given by the following equation:

$$T_{DIS} = \begin{cases} T_{DEM} & \text{(for DCM mode)} \\ T_{OFF} & \text{(for CCM mode)} \end{cases}$$
(3)

In Eq.(3),  $T_{DIS}=T_{DEM}$  for DCM operation and  $T_{DIS}=T_{OFF}$  for CCM operation respectively.

Combined with Eq.(1) to Eq. (3), the average output current lout can be expressed as:

$$I_{OUT} = N \times I_{mid\_P} \times \frac{T_{DIS}}{T_S} = N \times \frac{V_{mid\_P}}{R_{CS}} \times \frac{T_{DIS}}{T_S}$$
 (4)

In Eq.(4),  $R_{CS}$  is the sensing resistor connected between the power MOSFET source to GND.  $V_{mid\_P}$  is sampled  $R_{CS}$  voltage at the middle of primary power MOSFET conduction time.

In FT8208, the product of  $V_{mid\_P}$  and  $T_{DIS}$  is kept constant by the IC's internal PWM CC regulation loop. The switching frequency is trimmed to 65KHz in FT8208. Therefore, the average output current lout will be well regulated and given by:

$$I_{\text{CC\_OUT}}(\text{mA}) = N \times \frac{V_{\text{CC\_Reg}}}{Rcs} \cong N \times \frac{200\text{mV}}{Rcs(\Omega)}$$
 (5)

# Demagnetization Detection without Auxiliary Winding

In FT8208, the transformer core demagnetization is detected by monitoring the coupling current flowing through the parasitic capacitor Crss between the drain and gate of power MOSFET. When the transformer is fully demagnetized, the drain voltage evolution is governed by the resonating energy transfer between the transformer inductor and the parasitic capacitance of the drain. These voltage oscillations create current oscillation in the parasitic capacitor Crss. A negative current takes place during the decreasing part of the drain oscillation, and a positive current during the increasing part. The transformer demagnetization time corresponds to the inversion of the current by detecting this point, as shown in Fig.3

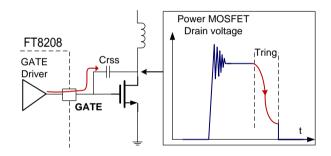


Fig.3

#### Mode Selection for CV and CC/CV

The load of SEL pin determines the operation mode of IC. In FT8208, the IC will work in CC/CV mode if an external capacitor is connected between SEL pin and GND. Otherwise, if SEL pin is floating, the IC will work in only CV mode.

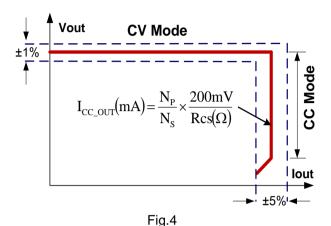
## ±5% CC Regulation, ±1% CV Regulation with Fast Dynamic Response

The CC algorithm in FT8208 compensates line variation and transformer inductance tolerance. The IC can achieve  $\pm 5\%$  CC regulation. The IC can

- 10 - 09/05/2014



also achieve  $\pm$ 1% CC regulation and fast dynamic response , due to the same control method as convention PWM controllers.



## Oscillator with Frequency Shuffling

PWM switching frequency in FT8208 is fixed to 65KHz and is trimmed to tight range. To improve system EMI performance, FT8208 operates the system with 4% frequency shuffling around setting frequency.

#### Built-in Slope Compensation

In the conventional application, the problem of the stability is a critical issue for current mode controlling, when it operates in higher than 50% of the duty-cycle. In FT8208 the slope compensation circuit is integrated by adding voltage ramp onto the current sense input voltage for PWM generation. This greatly improves the close loop stability at CCM and prevents the sub-harmonic oscillation and thus reduces the output ripple voltage.

#### Leading Edge Blanking (LEB)

Each time the power MOSFET is switched on, a turn-on spike occurs across the sensing resistor. The spike is caused by primary side capacitance and secondary side rectifier reverse recovery. To avoid premature termination of the switching pulse, an internal leading edge blanking circuit is built in.

During this blanking period (250ns, typical), the PWM comparator is disabled and cannot switch off the gate driver.

## Green Mode Operation

Since the main power dissipation at light/zero load in a switching mode power supply is from the switching loss which is proportional to the PWM switching frequency. To meet green mode requirement, it is necessary to reduce the switching cycles under such conditions either by skipping some switching pulses or by reducing the switching frequency.

## **Smooth Frequency Foldback**

In FT8208, a Proprietary "Smooth Frequency Foldback" function is integrated to foldback the PWM switching frequency when the loading is light. Compared to the other frequency reduction implementations, this technique can reduce the PWM frequency smoothly without audible noise.

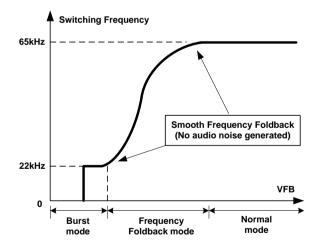


Fig.5

#### **Burst Mode Control**

When the loading is very small, the system enters into burst mode. When VFB drops below Vskip, U6201 will stop switching and output voltage starts to drop (as shown in Fig.6), which causes the VFB

- 11 - 09/05/2014



to rise. Once VFB rises above Vskip, switching resumes. Burst mode control alternately enables and disables switching, thereby reducing switching loss in standby mode.

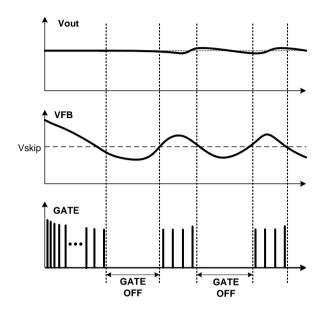


Fig.6

## On Chip Thermal Shutdown (OTP)

When the IC temperature is over 165 °C, the IC shuts down. Only when the IC temperature drops to 140 °C, IC will restart.

## Soft Start

FT8208 features an internal 20ms (typical) soft start that slowly increases the threshold of cycle-by-cycle current limiting comparator during startup sequence. It helps to prevent transformer saturation and reduce the stress on the secondary diode during startup. Every restart attempt is followed by a soft start activation.

#### Constant Power Limiting in CV Mode

In CV mode, a proprietary "Constant Power Limiting" block is integrated to achieve constant maximum output power capability over universal AC input range. Based on the duty cycle

information, the IC generates OCP threshold according to a proprietary analog algorithm.

# Short Load Protection (SLP) in CC/CV Mode

In FT8208, if the IC works in CC/CV mode and CC voltage is below 0.7V, the IC will enter into Short Load Protection (SLP) mode, in which the IC will enter into auto recovery protection mode.

## Over Load Protection (OLP) in CV Mode

In CV mode and if over load occurs, a fault is detected. If this fault is present for more than 43ms (typical), the protection will be triggered, the IC will experience an auto-recovery mode protection as mentioned above. The 43ms delay time is to prevent the false trigger from the power-on and turn-off transient

## VDD Over Voltage Protection (OVP) and Zener Clamp

When VDD voltage is higher than 28.5V (typical), the IC will stop switching. This will cause VDD fall down to be lower than  $V_{DD\_OFF}$  (typical 9V) and then the system will restart up again. An internal 32V (typical) zener clamp is integrated to prevent the IC from damage.

## Auto Recovery Mode Protection

As shown in Fig.7, once a fault condition is detected, PWM switching will stop. This will cause VDD to fall because no power is delivered form the auxiliary winding. When VDD falls to V<sub>DD\_OFF</sub> (typical 9V), the protection is reset and the operating current reduces to the startup current, which causes VDD to rise. The system begins switching when VDD reaches to V<sub>DD\_ON</sub> (typical 14V). However, if the fault still exists, the system will experience the above mentioned process. If the fault has gone, the system resumes normal operation. In this manner, the auto restart can



alternatively enable and disable the switching until the fault condition is disappeared.

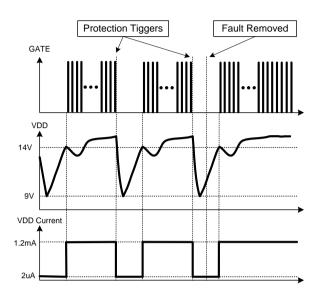


Fig.7

#### **Soft Gate Driver**

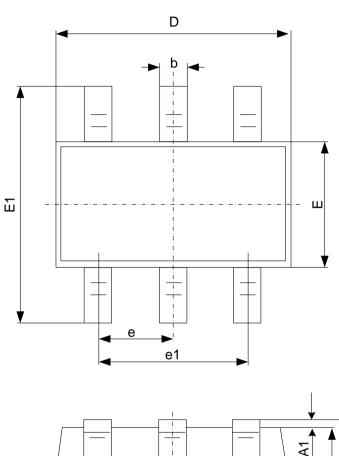
Offline Current Mode PWM Controller with Built-in CC Regulation

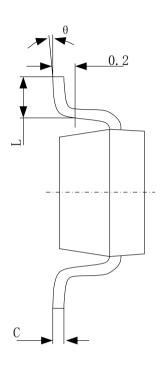
The output stage of FT8208 is a totem-pole gate driver with 400mA capability. Cross conduction has been avoided to minimize heat dissipation, increase efficiency, and enhance reliability. An internal 16V clamp is added for MOSFET gate protection at higher than expected VDD input. A soft driving waveform is implemented to minimize EMI.

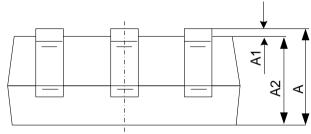


# **Package Dimension**

# SOT23-6







Symbol	Dimensions In Millimeters		Dimension	s In Inches
Symbol	Min	Max	Min	Max
А	0.900	1.200	0.035	0.047
A1	0.000	0.150	0.000	0.006
A2	0.900	1.100	0.035	0.043
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.800	3.020	0.110	0.119
E	1.500	1.700	0.059	0.067
E1	2.600	3.000	0.102	0.118
е	0.950 (BSC)		0.037	(BSC)
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	00	8°	00	8º